

**PRODUCT / PROCESS CHANGE NOTIFICATION**

**1. PCN basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCN No.</b>	MDG/19/10633	
<b>1.3 Title of PCN</b>	STM32H743, STM32H753 & STM32H750 products - new die revision	
<b>1.4 Product Category</b>	STM32H743, STM32H753 & STM32H750 products	
<b>1.5 Issue date</b>	2019-04-07	

**2. PCN Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	ROBERTSON HEATHER
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<b>2.2 Change responsibility</b>	
<b>2.2.1 Product Manager</b>	Ricardo Antonio DE SA EARP
<b>2.1.2 Marketing Manager</b>	Veronique BARLATIER
<b>2.1.3 Quality Manager</b>	Pascal NARCHE

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
General Product & Design	Die redesign: Mask or mask set change with new die design - Design changes in active elements.	Crolles 300

**4. Description of change**

	Old	New
<b>4.1 Description</b>	<p>STM32H743, STM32H753 &amp; STM32H750 : revision Y</p> <ul style="list-style-type: none"> <li>- Datasheet DS12110 Revision 5 for STM32H743xl products</li> <li>- Datasheet DS12117 Revision 5 for STM32H753xl products</li> <li>- Datasheet DS12556 Revision 2 for STM32H750VB &amp; STM32H750IB &amp; STM32H750XB products</li> </ul> <p>Limitations are described in Errata sheets :</p> <ul style="list-style-type: none"> <li>- Errata sheet ES0392 Revision 4 for STM32H743xl products</li> <li>- Errata sheet ES0396 Revision 4 for STM32H750xB and STM32H753xl products</li> </ul>	<p>STM32H743, STM32H753 &amp; STM32H750 : new die revision V</p> <ul style="list-style-type: none"> <li>- Datasheet DS12110 Revision 6 for STM32H743xl products</li> <li>- Datasheet DS12117 Revision 6 for STM32H753xl products</li> <li>- Datasheet DS12556 Revision 3 for STM32H750VB &amp; STM32H750IB &amp; STM32H750XB products</li> </ul> <p>Limitations are described in Errata sheets :</p> <ul style="list-style-type: none"> <li>- Errata sheet ES0392 Revision 5 for STM32H743xl products</li> <li>- Errata sheet ES0396 Revision 5 for STM32H750xB and STM32H753xl products</li> </ul> <p>ST MCD Division is pleased to announce features of STM32H743, STM32H753 &amp; STM32H750 products will be enhanced through the introduction of new die revision.</p> <ul style="list-style-type: none"> <li>• All system issues fixed (refer to errata sheets).</li> <li>• ADC improvements allowing better performances and efficient concurrent usage.</li> <li>• Fixed IP limitations (refer to errata sheets).</li> </ul>
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	Function : improvements are indicated in Datasheets and errata sheets	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	The strategy of ST MCD Division is to increase the robustness and improve performances, quality and functionality of our products. This is achieved by introducing new die revision for STM32H743, STM32H753 & STM32H750 products.
<b>5.2 Customer Benefit</b>	QUALITY IMPROVEMENT

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	The die revision change, see table in 10633 Detailed description document attached. It is marked onto the package of the part.
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7. Timing / schedule	
<b>7.1 Date of qualification results</b>	2019-03-19
<b>7.2 Intended start of delivery</b>	2019-04-19
<b>7.3 Qualification sample available?</b>	Not Applicable

8. Qualification / Validation			
<b>8.1 Description</b>	10633 PCN10633_Die_450XXXV_Qualification_plan.pdf		
<b>8.2 Qualification report and qualification results</b>	Available (see attachment)	<b>Issue Date</b>	2019-04-07

9. Attachments (additional documentations)	
10633 Public product.pdf 10633 PCN10633_Die_450XXXV_Qualification_plan.pdf 10633 PCN10633_Additional information.pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32H743BIT6	
	STM32H743IIK6	
	STM32H743IIT6	
	STM32H743VIT6	
	STM32H743XIH6	
	STM32H743ZIT6	
	STM32H750IBK6	
	STM32H750VBT6	
	STM32H750XBH6	
	STM32H753BIT6	
	STM32H753IIK6	
	STM32H753IIT6	
	STM32H753VIT6	
	STM32H753XIH6	
	STM32H753ZIT6	



## Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

**PCN Title :** STM32H743, STM32H753 & STM32H750 products - new die revision

**PCN Reference :** MDG/19/10633

**Subject :** Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM32H753ZIT6	STM32H743VIH6	STM32H743IIK6
STM32H753IIT6	STM32H753IIK6	STM32H753AII6
STM32H750IBK6	STM32H753BIT6	STM32H753VIH6
STM32H750XBH6	STM32H743IIT6	STM32H750VBT6
STM32H743IIK6TR	STM32H753XIH6	STM32H743BIT6
STM32H753VIT6	STM32H743AII6	STM32H743XIH6
STM32H743VIT6	STM32H743ZIT6	STM32H743AII6TR



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